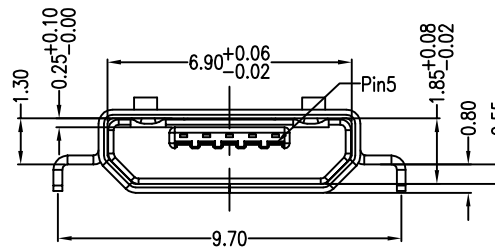
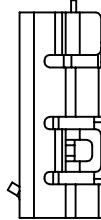
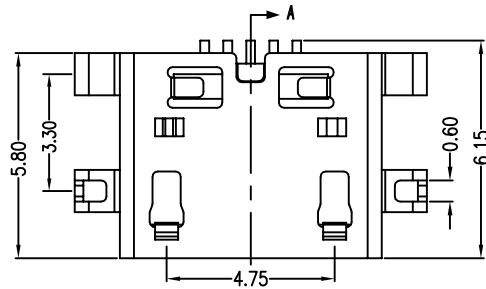
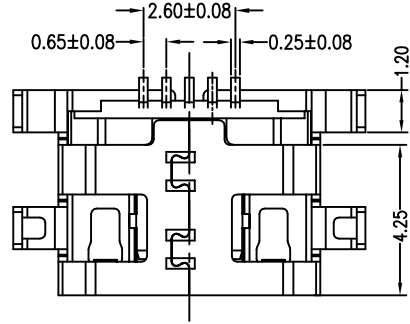
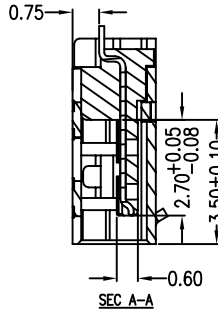
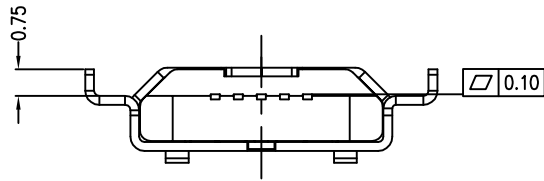


**RoHS Compliant**



Note:

1.Material:

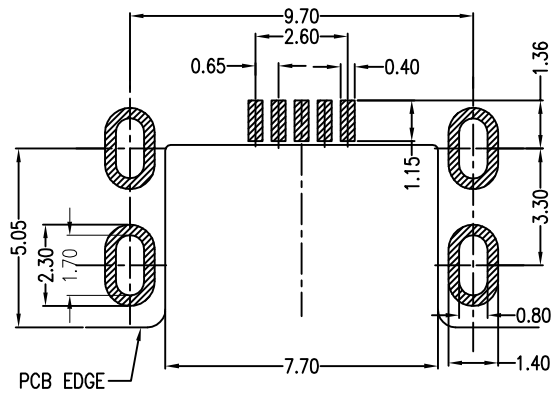
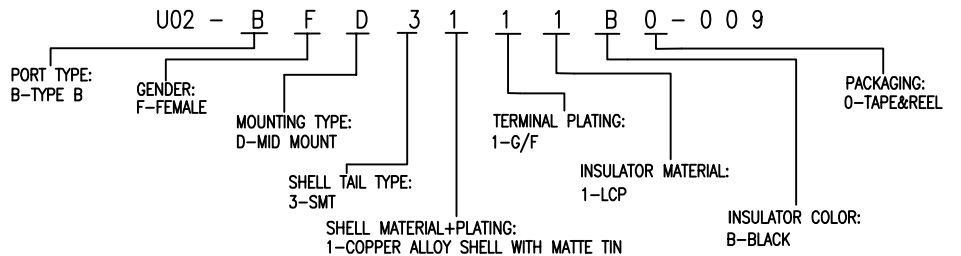
- 1.1 Housing: High temperature thermoplastic with g.f,UL94v-0
- 1.2 Contact: copper alloy,t=0.15mm
- 1.3 Shell: copper alloy or SUS,t=0.25mm

2.Specification:

- 2.1 Current rating:1,5PIN 1.8A Max/2,3,4PIN 1A Max.
- 2.2 Dielectric withstanding voltage: 100 V(ac) for 1 min.
- 2.3 Contact resistance: 30 mΩ Max.
- 2.4 Insulation resistance: 100 MΩ Min.
- 2.5 Total mating force: 3.57 Kgf Max.
- 2.6 Total unmating force: 1.0 Kgf Min.
- 2.7 Temperature range: -30°C~80°C

3.Part no.

PART NO.



RECOMMENDED PCB LAYOUT  
PCB图仅供参考

ECN. NO	REV	DATE	DESCRIPTION	CHANGED	APPROVED	UNIT: mm
	A	14.04.15	NEW RELEASE	L.RC	Kim	

▼ = Places	TOLERANCES UNLESS	
DIM NO. Ⓢ	X. ± 0.50	X' ± 3'
SCALE: FIT	.X ± 0.30	.X' ± 2'
	.XX ± 0.20	.XX' ± 1'
	.XXX ± 0.10	.XXX' ± 0.5'

BSC Electronics Co.,LTD		
DESIGN-YL	DATE: 2014.04.15	Micro usb 5s B Type
L.RC	CHECKED:	Smt 沉板 0.8四脚全插
	DATE:	无导线有孔
APPROVED:	DATE:	PART NO: U02-BFD31180-009
		SIZE: A4
		DWG NO: U02-BFD31180-009
		REV: A